**OKI** Semiconductor

# MSM80C154S/83C154S

#### **CMOS 8-bit Microcontroller**

#### **GENERAL DESCRIPTION**

The MSM80C154S/MSM83C154S, designed for the high speed version of the existing MSM80C154/MSM83C154, is a higher performance 8-bit microcontroller providing low-power consumption.

The MSM80C154S/MSM83C154S covers the functions and operating range of the existing MSM80C154/83C154/80C51F/80C31F.

The MSM80C154S is identical to the MSM83C154S except it does not contain the internal program memory (ROM).

#### FEATURES

<ul> <li>Operating range</li> </ul>	
Operating frequency	: 0 to 3 MHz ( $V_{cc}$ =2.2 to 6.0 V)
	0 to 12 MHz (V <sub>cc</sub> =3.0 to 6.0 V)
	0 to 24 MHz (V <sub>cc</sub> =4.5 to 6.0 V)
Operating voltage	: 2.2 to 6.0 V
Operating temperature	: -40 to +85°C (Operation at +125°C conforms to
	the other specification.)
<ul> <li>Fully static circuit</li> </ul>	
• Upward compatible with the MSM80C51	1F/80C31F
<ul> <li>On-chip program memory</li> </ul>	: 16K words x 8 bits ROM (MSM83C154S only)
<ul> <li>On-chip data memory</li> </ul>	: 256 words x 8 bits RAM
• External program memory address space	
<ul> <li>External data memory address space</li> </ul>	: 64K bytes RAM
• I/O ports	: 4 ports x 8 bits
(Port 1, 2, 3, impedance programmable)	
• 16-bit timer/counters	: 3
<ul> <li>Multifunctional serial port</li> </ul>	: I/O Expansion mode
	: UART mode (featuring error detection)
<ul> <li>6-source 2-priority level</li> </ul>	
Interrupt and multi-level	
Interrupt available by programming IP a	
Memory-mapped special function register	ters
• Bit addressable data memory and SFRs	
Minimum instruction cycle	: 500 ns @ 24 MHz operation
Standby functions	: Power-down mode (oscillator stop)
	Activated by software or hardware; providing
	ports with floating or active status
	The software power-down stet mode is termi-
	nated by interrupt signal enabling execution from
	the interrupted address.

•	Package options			
	40-pin plastic DIP (DIP40-P-600-2.54)	:	(Product name:	MSM80C154SRS/
				MSM83C154S-xxxRS)
	44-pin plastic QFP (QFP44-P-910-0.80-2K)	:	(Product name:	MSM80C154SGS-2K/
				MSM83C154S-xxxGS-2K)
	44-pin QFJ (QFJ44-P-S650-1.27)	:	(Product name:	MSM80C154SJS/
				MSM83C154S-xxxJS)
	44-pin TQFP (TQFP44-P-1010-0.80-K)	:	(Product name:	MSM80C154STS-K/
				MSM83C154S-xxxTS-K)

xxx: indicates the code number





# **PIN CONFIGURATION (TOP VIEW)**





# **PIN CONFIGURATION (Continued)**



NC: No-connection pin

44-Pin Plastic QFP



NC: No-connection pin

44-Pin Plastic TQFP

# **PIN CONFIGURATION (Continued)**



NC: No-connection pin

44-Pin Plastic QFJ

# **PIN DESCRIPTIONS**

Symbol	Descriptipn
P0.0 to P0.7	Bidirectional I/O ports. They are also the data/address bus (input/output of data and output of lower 8-bit address when external memory is accessed). They are open-drain outputs when used as I/O ports, but 3-state outputs when used as data/address bus.
P1.0 to P1.7	<ul> <li>P1.0 to P1.7 are quasi-bidirectional I/O ports. They are pulled up internally when used as input ports. Two of them have the following secondary functions:</li> <li>•P1.0 (T2) : used as external clock input pins for the timer/counter 2.</li> <li>•P1.1 (T2EX) : used as trigger input for the timer/counter 2 to be reloaded or captured; causing the timer/counter 2 interrupt.</li> </ul>
P2.0 to P2.7	P2.0 to P2.7 are quasi-bidirectional I/O ports. They also output the higher 8-bit address when an external memory is accessed. They are pulled up internally when used as input ports.
P3.0 to P3.7	P3.0 to P3.7 are quasi-bidirectional I/O ports. They are pulled up internally when used as input ports. They also have the following secondary functions: •P3.0 (RXD)
	Serial data input/output in the I/O expansion mode and serial data input in the UART mode when the serial port is used. •3.1 (TXD)
	Synchronous clock output in the I/O expansion mode and serial data output in the UART mode when the serial port is used. •3.2 (INTO)
	Used as input pin for the external interrupt 0, and as count-up control pin for the timer/counter 0. •3.3 (INT1)
	Used as input pin for the external interrupt 1, and as count-up control pin for the timer/counter 1. •3.4 (T0)
	Used as external clock input pin for the timer/counter 0. •3.5 (T1)
	Used as external clock input pin for the timer/counter 1 and power-down-mode control input pin. •3.6 (WR)
	Output of the write-strobe signal when data is written into external data memory. •3.7 (RD)
	Output of the read-strobe signal when data is read from external data memory.
ALE	Address latch enable output for latching the lower 8-bit address during external memory access. Two ALE pulses are activated per machine cycle except during external data memory access at which time one ALE pulse is skipped.
PSEN	Program store enable output which enables the external memory output to the bus during external program memory access. Two PSEN pulses are activated per machine cycle except during external data memory access at which two PSEN pulses are skipped.
ĒĀ	When EA is held at "H" level, the MSM 83C154S executes instructions from internal program memory at address 0000H to 3FFFH, and executes instructions from external program memory above address 3FFFH. When EA is held at "L" level, the MSM80C154S/MSM83C154S executes instructions from external program memory for all addresses.

# **PIN Descriptions (Continued)**

Symbol	Descriptipn
RESET	If this pin remains "H" for at least one machine cycle, the MSM80C154S/MSM83C154S is reset. Since this pin is pulled down internally, a power-on reset is achieved by simply connecting a capacitor between $V_{CC}$ and this pin.
XTAL1	Oscillator inverter input pin. External clock is input through XTAL1 pin.
XTAL2	Oscillator inverter output pin.
V <sub>CC</sub>	Power supply pin during both normal operation and standby operations.
V <sub>SS</sub>	GND pin.

# REGISTERS

# **Diagram of Special Function Registers**

REGISTER				BIT AD	DRESS				DIRECT
NAME	b7	b6	b5	b4	b3	b2	b1	b0	ADDRESS
IOCON	FF	FE	FD	FC	FB	FA	F9	F8	0F8H (248)
В	F7	F6	F5	F4	F3	F2	F1	F0	0F0H (240)
ACC	E7	E6	E5	E4	E3	E2	E1	E0	0E0H (224)
PSW	D7	D6	D5	D4	D3	D2	D1	D0	0D0H (208)
TH2									0CDH (205)
TL2									0CCH (204)
RCAP2H									0CBH (203)
RCAP2L									0CAH (202)
T2CON	CF	CE	CD	CC	СВ	CA	C9	C8	0C8H (200)
IP	BF	BE	BD	BC	BB	BA	B9	B8	0B8H (184)
P3	B7	B6	B5	B4	B3	B2	B1	B0	0B0H (176)
IE	AF	AE	AD	AC	AB	AA	A9	A8	0A8H (168)
P2	A7	A6	A5	A4	A3	A2	A1	A0	0A0H (160)
SBUF									99H (153)
SCON	9F	9E	9D	9C	9B	9A	99	98	98H (152)
P1	97	96	95	94	93	92	91	90	90H (144)
TH1									8DH (141)
TH0									8CH (140)
TL1									8BH (139)
TL0									8AH (138)
TMOD									89H (137)
TCON	8F	8E	8D	8C	8B	8A	89	88	88H (136)
PCON									87H (135)
DPH									83H (131)
DPL									82H (130)
SP									81H (129)
P0	87	86	85	84	83	82	81	80	80H (128)

#### **Special Function Registers**

# Timer mode register (TMOD)

NAME	ADDRESS	MSB							LSB		
NAME	ADDRESS	7	6	5	4	3	2	1	0		
TMOD	89H	GATE	C/T	M1	MO	GATE	C/T	M1	MO		
BIT LOCATION	FLAG				FUNG	CTION					
TMOD.0	MO	M1	MO	Timer/co	unter 0 m	ode setting					
		0	0	8-bit tim	er/counter	with 5-bit	prescalar.				
		0	1	16-bit tin	ner/counte	er.					
		1	0	0 8-bit timer/counter with 8-bit auto reloading.							
TMOD.1	M1	1	1	Timer/counter 0 separated into TLO (8-bit) timer/counter and THO (8-bit) timer/counter. TFO is set by TLO carry, and TF1 is set by THO carry.							
TMOD.2	C/T	XTAL1•2 C/T = "0".	divided by	y 12 clocks	is the inp	n control bir ut applied t is the input	o timer/co				
TMOD.3	GATE	control th If this bit	ie start an is "1", tim	d stop of ti er/counter	mer/count 0 starts co	l (timer con ter 0 counti ounting whe ops countir	ng. en both th	e TRO bit o	of TCON		
TMOD.4	MO	M1	MO	Timer/co	unter 1 m	ode setting					
		0	0	8-bit tim	er/counter	with 5-bit	prescalar.				
		0	1	16-bit tin	ner/counte	r					
TMOD.5	M1	1	0	8-bit tim	er/counter	with 8-bit a	auto reloa	ding.			
TWOD.5		1	1	Timer/co	unter 1 op	eration sto	pped.				
TMOD.6	C/T	XTAL1•2 C/T = "0".	Timer/counter 1 count clock designation control bit. XTAL1•2 divided by 12 clocks is the input applied to timer/counter 1 when $C/\overline{T} = "0"$ . The external clock applied to the T1 pin is the input applied to timer/counter 1								
TMOD.7	GATE	When this timer/cou If this bit	s bit is "0" inter 1 co is "1", tim	unting. er/counter	1 starts co	l is used to punting whe ops countir	en both th	e TR1 bit c	of TCON		

#### Power control register (PCON)

NAME	ADDRESS	MSB							LSB		
	ABBILLOO	7	6	5	4	3	2	1	0		
PCON	87H	SMOD	HPD	RPD		GF1	GF0	PD	IDL		
<b>BIT LOCATION</b>	FLAG				FUNC	TION					
PCON.0	IDL	IDLE mod and the s	de is set, b erial port r	hen this bi ut XTAL1• remain acti t is genera	2, timer/co ve. IDLE n	unters 0, 1	l and 2, th	e interrupt	circuits,		
PCON.1	PD	PD mode is set when this bit is set to "1". CPU operations and XTAL1•2 are stopped when PD mode is set. PD mode is cancelled when the CPU is reset or when an interrupt is generated.									
PCON.2	GF0	General p	ourpose bit								
PCON.3	GF1	General p	ourpose bit								
PCON.4	_	Reserved	bit. The c	output data	is "1", if th	e bit is rea	ıd.				
PCON.5	RPD	interrupt Power-do enabled t If the inte "1" (even of the po	signal. own mode oy IE (inter errupt flag if interrupt wer-down-		cancelled I e register) ' by an inte d), the pro ing instruc	by an inter when this errupt requ gram is ex	rupt signal bit is "0". est signal	if the inte when this			
PCON.6	HPD	The hard power-down setting mode in enabled when this bit is set to "1". If the level of the power failure detect signal applied to the HPDI pin (pin 3.5) is changed from "1" to "0" when this bit is "1", XTAL1•2 oscillation is stopped and the system is put into hard power down mode. HPD mode is cancelled when the CPU is reset.									
PCON.7	SMOD	CPU is reset. When the timer/counter 1 carry signal is used as a clock in mode 1, 2 or 3 of the serial port, this bit has the following functions. The serial port operation clock is reduced by 1/2 when the bit is "0" for delayed processing. When the bit is "1", the serial port operation clock is normal for faster processing.									

#### Timer control register (TCON)

NAME	ADDRESS	MSB							LSB		
INAIVIE	ADDRESS	7	6	5	4	3	2	1	0		
TCON	88H	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0		
BIT LOCATION	FLAG		1		FUNC	TION					
TCON.0	IT0		nterrupt 0 etect mode	signal is u when "1".	sed in leve	I-detect m	ode when	this bit is "	0" and in		
TCON.1	IEO	The bit is	nterrupt request flag for external interrupt 0. The bit is reset automatically when an interrupt is serviced. The bit can be set and reset by software when ITO = "1".								
TCON.2	IT1		External interrupt 1 signal is used in level detect mode when this bit is "0", and in trigger detect mode when "1".								
TCON.3	IE1	The bit is	Interrupt request flag for external interrupt 1. The bit is reset automatically when an interrupt is serviced. The bit can be set and reset by software when IT1 = "1".								
TCON.4	TR0			stop contro rts countin				s counitng	when "0".		
TCON.5	TF0	The bit is	reset auto	ig for timei matically v when a car	vhen an int	errupt is s		er/counter	0.		
TCON.6	TR1		Counting start and stop control bit for timer/counter 1. The timer/counter 1 starts counting when this bit is "1", and stops counting when "0".								
TCON.7	TF1	The bit is	reset auto	ig for timei matically v when carry	vhen interr	upt is serv		/counter 1			

# Serial port control register (SCON)

		MSB							LSB		
NAME	ADDRESS	7	6	5	4	3	2	1	0		
SCON	98H	SM0	SM1	SM2	REN	TB8	RB8	TI	RI		
BIT LOCATION	FLAG				FUNC	TION	1				
SCON.0	RI	This flag This flag by the ST In mode 3	must be re is set after OP bit whe 2 or 3, hov	eset by sof the eighth en in any c vever, RI is	nterrupt ree tware durin bit of data ther mode s not set if t is received	g interrup has been the RB8 d	received v ata is "0" v	vhen in mo			
SCON.1	TI	by softwa This flag	re during is set after	interrupt s the eighth	on" interrup ervice rout 1 bit of data ent when in	ine. has been	sent when	-			
SCON.2	RB8	The STOF	The ninth bit of data received in mode 2 or 3 is passed to RB8. The STOP bit is applied to RB8 if SM2 = "0" when in mode 1. RB8 can not be used in mode 0.								
SCON.3	TB8				nth data bit TB8 by so		node 2 or 3	3.			
SCON.4	REN	No recept	n enable co tion when n enabled v		= "1".						
SCON.5	SM2	reception The "end	" signal is	not set in t on" signal s	a is "0" with he RI flag. set in the R						
SCON.6	SM1	SM0	SM1	MODE	1						
		0	0	0	8-bit shift	register l	/0				
		0	1	1	8-bit UAF	T variable	baud rate				
SCON.7	SM0	1	0	2	9-bit UAF	T 1/32 XT	AL1, 1/64	XTAL1 ba	ud rate		
		1	1	3	9-bit UAF	T variable	baud rate				

# Interrupt enable register (IE)

NAME	ADDRESS	MSB							LSB		
NAME	ADDRE55	7	6	5	4	3	2	1	0		
IE	0A8H	EA	_	ET2	ES	ET1	EX1	ET0	EX0		
BIT LOCATION	FLAG				FUNC	CTION					
IE.0	EX0	Interrupt	disabled w	for extern /hen bit is hen bit is "	'0".	t 0.					
IE.1	ET0	Interrupt	nterrupt control bit for timer interrupt 0. nterrupt disabled when bit is "0". nterrupt enabled when bit is "1".								
IE.2	EX1	Interrupt	nterrupt control bit for external interrupt 1. nterrupt disabled when bit is "0". nterrupt enabled when bit is "1".								
IE.3	ET1	Interrupt	disabled w	for timer i /hen bit is hen bit is "	'0".						
IE.4	ES	Interrupt	disabled w	for serial /hen bit is hen bit is "	'0".						
IE.5	ET2	Interrupt	nterrupt control bit for timer interrupt 2. nterrupt disabled when bit is "0". nterrupt enabled when bit is "1".								
IE.6	_	Reserved bit. The output data is "1" if the bit is read.									
IE.7	EA	All interru	Reserved bit. The output data is "1" if the bit is read. Overall interrupt control bit. All interrupts are disabled when bit is "0". All interrupts are controlled by IE.0 thru IE.5 when bit is "1".								

# Interrupt priority register (IP)

NAME	ADDRESS	MSB							LSB			
NAME	ADDRESS	7	6	5	4	3	2	1	0			
IP	0B8H	PCT	PCT — PT2 PS PT1 PX1 PT0 PX0									
<b>BIT LOCATION</b>	FLAG		FUNCTION									
IP.0	PX0		nterrupt priority bit for external interrupt 0. riority is assigned when bit is "1".									
IP.1	PT0		terrupt priority bit for timer interrupt 0. iority is assigned when bit is "1".									
IP.2	PX1		nterrupt priority bit for external interrupt 1. riority is assigned when bit is "1".									
IP.3	PT1			t for timer i when bit is								
IP.4	PS			t for serial when bit is								
IP.5	PT2			t for timer i when bit is								
IP.6		Reserved	bit. The c	output data	is "1" if th	e bit is rea	d.					
IP.7	PCT	The prior processe	eserved bit. The output data is "1" if the bit is read. riority interrupt circuit control bit. he priority register contents are valid and priority assigned interrupts can be rocessed when this bit is "0". When the bit is "1", the priority interrupt circuit is topped, and interrupts can only be controlled by the interrupt enable register (IE).									

# Program status word register (PSW)

NAME	ADDRESS	MSB							LSB		
		7	6	5	4	3	2	1	0		
PSW	0D0H	CY	AC	F0	RS1	RS0	OV	F1	Р		
<b>BIT LOCATION</b>	FLAG				FUNC	TION					
PSW.0	Ρ	This bit is			cator. number in	the accum	ulator is a	n odd num	ıber, and		
PSW.1	F1	User flag	User flag which may be set to "0" or "1" as desired by the user.								
PSW.2	OV	result of a of execut	an arithme ing multipl	tic operation lication ins		g is also s 1UL AB) is	et to "1" if	the resulta	"1" as a int product out is reset		
PSW.3	RS0	RAM register bank switch									
		RS1	RS0	BANK		RA	M ADDRE	SS			
		0	0	0	00H - 07ł	4					
PSW.4	RS1	0	1	1	08H - 0Fł	ł					
		1	0	2	10H - 17H	1					
		1	1	3	18H - 1FH	4					
PSW.5	FO	User flag	which may	y be set to	"0" or "1" a	s desired b	by the use	r.			
PSW.6	AC	This flag executing	User flag which may be set to "0" or "1" as desired by the user. Auxiliary carry flag. This flag is set to "1" if a carry $C_3$ is generated from bit 3 of the ALU as a result of executing an arithmetic operation instruction. In all other cases, the flag is reset to "0".								
PSW.7	CY	Main carry flag. This flag is set to "1" if a carry $C_7$ is generated from bit 7 of the ALU as result of executing an arithmetic operation instruction. If a carry $C_7$ is not generated, the flag is reset to "0".									

# I/O control register (IOCON)

		MSB							LSB
NAME	ADDRESS	7	6	5	4	3	2	1	0
IOCON	0F8H	_	T32	SERR	IZC	P3HZ	P2HZ	P1HZ	ALF
BIT LOCATION	FLAG				FUNC	TION	1		
IOCON.0	ALF	outputs f	f CPU power down mode (PD, HPD) is activated with this bit set to "1", the putputs from ports 0, 1, 2, and 3 are switched to floating status. When this bit is "0", ports 0, 1, 2, and 3 are in output mode.						
IOCON.1	P1HZ	Port 1 be	comes a h	igh impeda	ance input	port when	this bit is	'1".	
IOCON.2	P2HZ	Port 2 be	Port 2 becomes a high impedance input port when this bit is "1".						
IOCON.3	P3HZ	Port 3 be	Port 3 becomes a high impedance input port when this bit is "1".						
IOCON.4	IZC			resistor for he 100 kΩ			switched o	ff when thi	s bit
IOCON.5	SERR	This flag received				ning error	is generat	ed when da	ata is
IOCON.6	T32	Timer/counters 0 and 1 are connected serially to from a 32-bit timer/counter when this bit is set to "1". TF1 of TCON is set if a carry is generated in the 32-bit timer/counter.							
IOCON.7	_	Leave this	Leave this bit at "0".						

#### Timer 2 control register (T2CON)

NAME	ADDRESS	MSB							LSB
NAME	ADDRE22	7	6	5	4	3	2	1	0
T2CON	0C8H	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2
BIT LOCATION	FLAG				FUNC	TION	1	1	
T2CON.0	CP/RL2	Capture mode is set when TCLK + RCLK = "0" and $CP/\overline{RL2}$ = "1". 16-bit auto reload mode is set when TCLK + RCLK = "0" and $CP/\overline{RL2}$ = "0". $CP/\overline{RL2}$ is ignored when TCLK + RCLK = "1".						0".	
T2CON.1	C/T2	The interi	nal clocks xternal clo	unt clock d (XTAL1•2 · ck applied	÷ 12, XTAL	.1•2 ÷ 2) a	re used wł		
T2CON.2	TR2		unter 2 col	unting star mmences (				l stops co	unting
T2CON.3	EXEN2			2 external ignal is dis				nabled wh	en "1".
T2CON.4	TCLK	Timer/con and the ti Note, how	unter 2 is s mer/count	circuit driv switched to ter 2 carry the serial s 1 and 3.	) baud rate signal beco	generator omes the s	erial port f	transmit cl	ock.
T2CON.5	RCLK	Timer/con and the ti Note, how	unter 2 is s mer/count	circuit drive switched to ter 2 carry the serial s 1 and 3.	) baud rate signal beco	generator omes the s	erial port f	transmit cl	ock.
T2CON.6	EXF2	Timer/col This bit is is change This flag	unter 2 ext s set to "1" d from "1" serves as f	ternal flag. when the to "0" whil the timer ir ust be rese	e EXEN2 = nterrupt 2 i	"1". request sig			
T2CON.7	TF2	Timer/co This bit is reload mo This flag	unter 2 car s set to "1" ode or in c serves as f		signal whe de. iterrupt 2 i	en timer/co request sig			

# **MEMORY MAPS**

#### **Program Area**

1	Î	65535	OFFFFH	] ;	Timer interrupt 2 start	43	002BH
	AREA -						
	MSM83C154S EXTERNAL ROM AREA				S I/O interrupt start	35	0023H
	TERNA					1	
REA	54S EX				Timer interrupt 1 start	27	001BH
MSM80C154S EXTERNAL ROM AREA	A83C15						
INAL F	MSN			1	External interrupt 1 start	19	0013H
XTEP	+	16384 16383	4000H 3FFFH	- /			
4S E		10000					
30C15	AREA			ļ	Timer interrupt 0 start	11	000BH
MSM	- ROM						
Ī	INAI .	44	002CH	. (			
	INTE	43	002BH		External interrupt 0 start	3	0003H
	iC154S					2	0002H
	MSM83C154S INTERNAL ROM AREA					1	0001H
_		0	7 6 5 4 3 2 1 0	]	CPU reset start	0	0000H

HEX					
0FF		1	IOCON	FFH~F8H	248(0F8H) 🖛
			В	F7H~F0H	240(0F0H) -
			ACC	E7H~E0H	224(0E0H) -
			PSW	D7H~D0H	208(0D0H) 🗲
			TH2		205(0CDH) -
			TL2		204(0CCH) -
			RCAP2H		203(OCBH) -
			RCAP2L		202(0CAH) -
		S	T2CON	CFH~C8H	200(0C8H) -
		ER	IP	BFH~B8H	184(0B8H) -
		ISI	P3	B7H~B0H	176(0B0H) -
		SEC	IE	AFH~A8H	168(0A8H) 🖛
		I NC	P2	A7H~A0H	160(0A0H) 🖛
	USER DATA RAM	CTIC	SBUF		153(99H) 🗲
		NN	SCON	9FH~98H	152(98H) 🗲
		L F	P1	97H~90H	144(90H) 🗲
		SPECIAL FUNCTION REGISTERS	TH1		141(8DH) 🖛
		SPE	TH0		140(8CH) -
			TL1		139(8BH) 🗲
			TL0		138( 8AH) 🗲
			TMOD		137(89H) 🗲
			TCON	8FH~88H	136(88H) 🗲
			PCON		135(87H) 🗲
			DPH		131(83H) 🗲
			DPL		130(82H) 🗲
			SP		129(81H) 🗲
80 7F		•	P0	87H~80H	128( 80H) 🗲
7 F					
	USER DATA RAM				
30					
30 2F	7F 78				
21	-				
0.0	BIT RAM				
20 1 F	7 0 R7	+ +	$\rightarrow$ $+$	BIT ADDRES	SSING
١F	BANK3				
18	RO	_			
17	R7	│			
10	BANK2				
0 F	R7	1			
00	BANK1				
08 07	R0 R7	-	C	< DATA ADDF	RESSING
	BANKO				
00	R0				

#### Internal Data Memory and Special Function Register Layout Diagram

# **Diagram of Internal Data Memory (RAM)**

0FFH									255			)
80H			l	JSER DA	ATA RAN	Λ			128			
7FH			1	JSER DA		Λ			127			
30H		1						1	48	<u>`</u>		
2FH	7F	7E	7D	7C	7B	7A	79	78	47			
2EH	77	76	75	74	73	72	71	70	46			
2DH	6F	6E	6D	6C	6B	6A	69	68	45			
2CH	67	66	65	64	63	62	61	60	44			ING
2BH	5F	5E	5D	5C	5B	5A	59	58	43			REGISTER 0, 1, INDIRECT ADDRESSING
2AH	57	56	55	54	53	52	51	50	42	ING	SING	r add
29H	4F	4E	4D	4C	4B	4A	49	48	41	BIT ADDRESSING	DATA ADDRESSING	IRECT
28H	47	46	45	44	43	42	41	40	40	ADDI	A ADI	, IND
27H	3F	3E	3D	3C	3B	3A	39	38	39	BIT	DAT	R 0, 1
26H	37	36	35	34	33	32	31	30	38			SISTE
25H	2F	2E	2D	20	2B	2A	29	28	37			REG
24H	27	26	25	24	23	22	21	20	36			
23H	1F	1E	1D	10	1B	1A	19	18	35			
22H	17	16	15	14	13	12	11	10	34			
21H	0F	0E	0D	0C	0B	0A	09	08	33			
20H	07	06	05	04	03	02	01	00	32			
1FH				Bar	1k 3				31	NG		
18H				Dai	IK J				24	ESSI		
17H						23	ADDR					
10H	Bank 2					16	REGISTERS 0-7 DIRIECT ADDRESSING					
0FH									15			
0011				Bar	nk <b>1</b>				0	S 0-7		
08H 07H									8	TER		
0/11	Bank 0						EGIS					
00H									0	) "	)	J

# **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>	Ta=25°C	-0.5 to 7	V
Input voltage	VI	Ta=25°C	-0.5 to V <sub>CC</sub> +0.5	V
Storage temperature	T <sub>STG</sub>		-55 to +150	°C

# **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Condition	Range	Unit
Power supply voltage	V <sub>CC</sub>	See below.	2.0 to 6.0	V
Memory retension voltage	V <sub>CC</sub>	f <sub>OSC</sub> =0 Hz (Oscillation stop)	2.0 to 6.0	V
Oxcillation frequency	f <sub>OSC</sub>	See below.	1 to 24	MHz
External clock operating frequency	fextclk	See below.	0 to 24	MHz
Ambient temperature	Та	—	-40 to +85	°C

\*1 Depends on the specifications for the oscillator or ceramic resonater.



# **ELECTRICAL CHARACTERISTICS**

#### **DC Characteristics 1**

(V<sub>CC</sub>=4.0 to 6.0 V, V<sub>SS</sub>=0 V, Ta=-40 to +85°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.		Meas- uring circuit		
Input Low Voltage	V <sub>IL</sub>		-0.5	—	0.2 V <sub>CC</sub> -0.1	V			
Input High Voltage	V <sub>IH</sub>	Except XTAL1, EA, and RESET	0.2 V <sub>CC</sub> +0.9	_	V <sub>CC</sub> +0.5	V			
Input High Voltage	V <sub>IH1</sub>	XTAL1, RESET and $\overline{EA}$	0.7 V <sub>CC</sub>	—	V <sub>CC</sub> +0.5	V	1		
Output Low Voltage (PORT 1, 2, 3)	V <sub>OL</sub>	I <sub>OL</sub> =1.6 mA	_	_	0.45	V			
Output Low Voltage (PORT 0, ALE, PSEN)	V <sub>0L1</sub>	I <sub>0L</sub> =3.2 mA	_	_	0.45	V	1		
Output High Voltage	Vari	I <sub>0H</sub> =–60 μΑ V <sub>CC</sub> =5 V±10%	2.4	-		V			
(PORT 1, 2, 3)	V <sub>OH</sub>	I <sub>0H</sub> =–30 μA	0.75 V <sub>CC</sub>	—		V			
		I <sub>0H</sub> =−10 μA	0.9 V <sub>CC</sub>	—		V			
Output High Voltage		I <sub>0H</sub> =–400 μΑ V <sub>CC</sub> =5 V±10%	2.4	_		V			
(PORT 0, ALE, PSEN)	V <sub>OH1</sub>	I <sub>0H</sub> =-150 μA	0.75 V <sub>CC</sub>	_		V			
		I <sub>0H</sub> =-40 μA	0.9 V <sub>CC</sub>	_		V			
Logical O Input Current/ Logical 1 Output Current/ (PORT 1, 2, 3)	I <sub>IL</sub> / I <sub>OH</sub>	V <sub>I</sub> =0.45 V V <sub>0</sub> =0.45 V	-5	-20	-80	μA	2		
Logical 1 to 0 Transition Output Current (PORT 1, 2, 3)	I <sub>TL</sub>	V <sub>I</sub> =2.0 V	_	-190	-500	μA			
Input Leakage Current (PORT 0 floating, EA)	ILI	$V_{SS} < V_I < V_{CC}$	_	_	±10	μA	3		
RESET Pull-down Resistance	R <sub>RST</sub>		20	40	125	kΩ	2		
Pin Capacitance	C <sub>IO</sub>	Ta=25°C, f=1 MHz (except XTAL1)		_	10	pF	_		
Power Down Current	I <sub>PD</sub>	—	—	1	50	μA	4		

Vcc	4 V	5 V	6 V
Freq			
1 MHz	2.2	3.1	4.1
3 MHz	3.9	5.2	7.0
12 MHz	12.0	16.0	20.0
16 MHz	16.0	20.0	25.0
20 MHz	19.0	25.0	30.0

# Maximum power supply current normal operation I<sub>CC</sub> (mA)

Vcc	4.5 V	5 V	6 V
Freq			
24 MHz	25.0	29.0	35.0

# Maximum power supply current idle mode I<sub>CC</sub> (mA)

Vcc	4 V	5 V	6 V
Freq			
1 MHz	0.8	1.2	1.6
3 MHz	1.2	1.7	2.3
12 MHz	3.1	4.4	5.9
16 MHz	3.8	5.5	7.3
20 MHz	4.5	6.4	8.6

Vcc	4.5 V	5 V	6 V
Freq			
24 MHz	6.4	7.4	9.8

#### **DC Characteristics 2**

(V <sub>CC</sub> =2.2 to 4.0 V, V <sub>SS</sub> =0 V, 1a=-40 t							,
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Meas- uring circuit
Input Low Voltage	V <sub>IL</sub>	—	-0.5		0.25 V <sub>CC</sub> -0.1	V	
Input High Voltage	VIH	Except XTAL1, EA, and RESET	0.25 V <sub>CC</sub> +0.9		V <sub>CC</sub> +0.5	V	
Input High Voltage	V <sub>IH1</sub>	XTAL1, RESET, and $\overline{\text{EA}}$	0.6 V <sub>CC</sub> +0.6	—	V <sub>CC</sub> +0.5	V	
Output Low Voltage (PORT 1, 2, 3)	V <sub>OL</sub>	I <sub>0L</sub> =10 μA	_		0.1	V	
Output Low Voltage (PORT 0, ALE, PSEN)	V <sub>OL1</sub>	I <sub>0L</sub> =20 μΑ	_		0.1	V	1
Output High Voltage Output High Voltage	V <sub>OH</sub>	I <sub>0H</sub> =–5 μA	0.75 V <sub>CC</sub>			V	
(PORT 1, 2, 3) (PORT 0, ALE, <u>PSEN</u> )	V <sub>OH1</sub>	I <sub>0H</sub> =−20 μA	0.75 V <sub>CC</sub>		_	V	
Logical 0 Input Current/ Logical 1 Output Current/ (PORT 1, 2, 3)	I <sub>IL</sub> / I <sub>OH</sub>	V <sub>I</sub> =0.1 V V <sub>0</sub> =0.1 V	-5	-10	-40	μA	2
Logical 1 to 0 Transition Output Current (PORT 1, 2, 3)	I <sub>TL</sub>	V <sub>I</sub> =1.9 V		-80	-300	μA	
Input Leakage Current (PORT 0 floating, EA)	ILI	$V_{SS} < V_I < V_{CC}$			±10	μA	3
RESET Pull-down Resistance	R <sub>RST</sub>	_	20	40	125	kΩ	2
Pin Capacitance	C <sub>IO</sub>	Ta=25°C, f=1 MHz (except XTAL1)	_		10	рF	_
Power Down Current	I <sub>PD</sub>			1	10	μA	4

#### (V<sub>CC</sub>=2.2 to 4.0 V, V<sub>SS</sub>=0 V, Ta=-40 to +85°C)

Vcc	2.2 V	3.0 V	4.0 V
Freq			
1 MHz	0.9	1.4	2.2
3 MHz	1.8	2.4	4.3
12 MHz	—	8.0	12.0
16 MHz	_	—	16.0

# Maximum power supply current normal operation $I_{CC}$ (mA)

# Maximum power supply current idle mode I<sub>CC</sub> (mA)

V <sub>CC</sub>	2.2 V	3.0 V	4.0 V
Freq			
1 MHz	0.3	0.5	0.8
3 MHz	0.5	0.8	1.2
12 MHz	—	2.0	3.1
16 MHz	_	—	3.8

#### **Measuring circuits**



- \*1: Repeated for specified input pins.
- \*2: Repeated for specified output pins.
- \*3: Input logic for specified status.

#### **AC Characteristics**

#### (1) External program memory access AC characteristics

PORT	0, ALE, and PS	V <sub>CC</sub> =2.2 to EN connected with 100pF lo	6.0V, V <sub>SS</sub> =0V, Ta=–40°( ad, other connected with	
	Symble	Variable o	clock from <sup>*1</sup>	
Parameter		1 to 2	Unit	
		Min.	Max.	
XTAL1, XTAL 2 Oscillation Cycle	t <sub>CLCL</sub>	41.7	1000	ns
ALE Signal Width	t <sub>LHLL</sub>	2t <sub>CLCL</sub> -40	_	ns
Address Setup Time (to ALE Falling Edge)	t <sub>AVLL</sub>	1t <sub>CLCL</sub> -15	—	ns
Address Hold Time (from ALE Falling Edge)	t <sub>LLAX</sub>	1t <sub>CLCL</sub> -35	_	ns
Instruction Data Read Time (from ALE Falling Edge)	t <sub>llpl</sub>	—	4t <sub>CLCL</sub> -100	ns
From ALE Falling Edge to PSEN Falling Edge	t <sub>LLPL</sub>	1t <sub>CLCL</sub> -30	_	ns
PSEN Signal Width	t <sub>PLPH</sub>	3t <sub>CLCL</sub> -35		ns
Instruction Data Read Time (from PSEN Falling Edge)	tpLIV	—	3t <sub>CLCL</sub> -45	ns
Instruction Data Hold Time (from PSEN Rising Edge)	t <sub>PXIX</sub>	0	_	ns
Bus Floating Time after Instruction Data Read (from PSEN Rising Edge)	t <sub>PXIZ</sub>	_	1t <sub>CLCL</sub> -20	ns
Instruction Data Read Time (from Address Output)	t <sub>AVIV</sub>	_	5t <sub>CLCL</sub> -105	ns
Bus Floating Time(PSEN Rising Edge from Address float)	t <sub>AZPL</sub>	0	_	ns
Address Output Time from PSEN Rising Edge	t <sub>PXAV</sub>	1t <sub>CLCL</sub> -20		ns

\*1 The variable check is from 0 to 24 MHz when the external check is used.

#### (2) External program memory read cycle



#### (3) External data memory access AC characteristics

(

V <sub>CC</sub> =2.2 to 6.0V, V <sub>SS</sub> =0V, Ta=-40°C to +85	°C \
PORT 0, ALE, and PSEN connected with 100pF load, other connected with 80pF load	ad /

Parameter	Symbol	Variable 1 to	Unit	
		Min.	Max.	
XTAL1, XTAL2 Oscillator Cycle	t <sub>CLCL</sub>	41.7	1000	ns
ALE Signal Width	t <sub>LHLL</sub>	2t <sub>CLCL</sub> -40	_	ns
Address Setup Time (to ALE Falling Edge)	t <sub>AVLL</sub>	1t <sub>CLCL</sub> -15	_	ns
Address Hold Time (from ALE Falling Edge)	t <sub>LLAX</sub>	1t <sub>CLCL</sub> -35	_	ns
RD Signal Width	t <sub>RLRL</sub>	6t <sub>CLCL</sub> -100	_	ns
WR Signal Width	t <sub>WLWH</sub>	6t <sub>CLCL</sub> -100	_	ns
RAM Data Read Time (from RD Signal Falling Edge)	t <sub>RLDV</sub>	_	5t <sub>CLCL</sub> -105	ns
RAM Data Read Hold Time (from RD Signal Rising Edge)	t <sub>RHDX</sub>	0	_	ns
Data Bus Floating Time (from RD Signal Rising Edge)	t <sub>RHDZ</sub>	_	2t <sub>CLCL</sub> -70	ns
RAM Data Read Time (from ALE Signal Falling Edge)	t <sub>LLDV</sub>	_	8t <sub>CLCL</sub> -100	ns
RAM Data Read Time (from Address Output)	t <sub>AVDV</sub>	_	9t <sub>CLCL</sub> -105	ns
RD/WR Output Time from ALE Falling Edge	tllwl	3t <sub>CLCL</sub> -40 *2 3t <sub>CLCL</sub> -100		ns
RD/WR Output Time from Address Output	t <sub>AVWL</sub>	4t <sub>CLCL</sub> -70	_	ns
WR Output Time from Data Output	t <sub>QVWX</sub>	1t <sub>CLCL</sub> -40	_	ns
Time from Data to WR Rising Edge	t <sub>QVWH</sub>	7t <sub>CLCL</sub> -105		ns
Data Hold Time (from WR Rising Edge)	twhax	2t <sub>CLCL</sub> -50	_	ns
Time from to Address Float RD Output	t <sub>RLAZ</sub>	0	_	ns
Time from RD/WR Rising Edge to ALE Rising Edge	twhlh	1t <sub>CLCL</sub> -30	1t <sub>CLCL</sub> +40 *2 1t <sub>CLCL</sub> +100	ns

\*1 The variable check is from 0 to 24 MHz when the external check is used.

\*2 For  $2.2 \le V_{CC} \le 4 V$ 

(4) External data memory read cycle

twhlh

# t<sub>LHLL</sub> ALE



#### (5) External data memory write cycle



#### (6) Serial port (I/O Extension Mode) AC characteristics

		(V <sub>CC</sub> =2.2 to 6.0V, V <sub>SS</sub> =0V, Ta=-40°C to +8			
Parameter	Symbol	Min.	Max.	Unit	
Serial Port Clock Cycle Time	t <sub>XLXL</sub>	12t <sub>CLCL</sub>	—	ns	
Output Data Setup to Clock Rising Edge	t <sub>QVXH</sub>	10t <sub>CLCL</sub> -133	—	ns	
Output Data Hold After Clock Rising Edge	t <sub>XHQX</sub>	2t <sub>CLCL</sub> -75	—	ns	
Input Data Hold After Clock Rising Edge	t <sub>XHDX</sub>	0	—	ns	
Clock Rising Edge to Input Data Valid	t <sub>XHDV</sub>		10t <sub>CLCL</sub> -133	ns	



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#### (7) AC Characteristics Measuring Conditions

1.Input/output signal



\* The input signals in AC test mode are either V<sub>OH</sub> (logic "1") or V<sub>OL</sub> (logic "0") input signals where logic "1" corresponds to a CPU output signal waveform measuring point in excess of V<sub>IH</sub>, and logic "0" to a point below V<sub>IL</sub>.

#### 2. Floating



\* The port 0 floating interval is measured from the time the port 0 pin voltage drops below V<sub>IH</sub> after sinking to GND at 2.4 mA when switching to floating status from a "1" output, and from the time the port 0 pin voltage exceeds V<sub>IL</sub> after connecting to a 400 µA source when switching to floating status from a "0" output.

#### (8) XTAL1 external clock input waveform conditions

Parameter	Symbol	Min.	Max.	Unit
External Clock Freq.	1/t <sub>CLCL</sub>	0	24	MHz
Clock Pulse width 1	t <sub>CHCx</sub>	15	_	ns
Clock Pulse width 2	t <sub>CLCX</sub>	15	_	ns
Rise Time	t <sub>CLCH</sub>	—	5	ns
Fall Time	t <sub>CHCL</sub>	—	5	ns

#### **External Clock Drive Waveform**



#### **Timing Diagram**

#### **Basic timing**



# PACKAGE DIMENSIONS

(Unit : mm)



Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, SOJ, QFJ (PLCC), SHP and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

(Unit : mm)



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